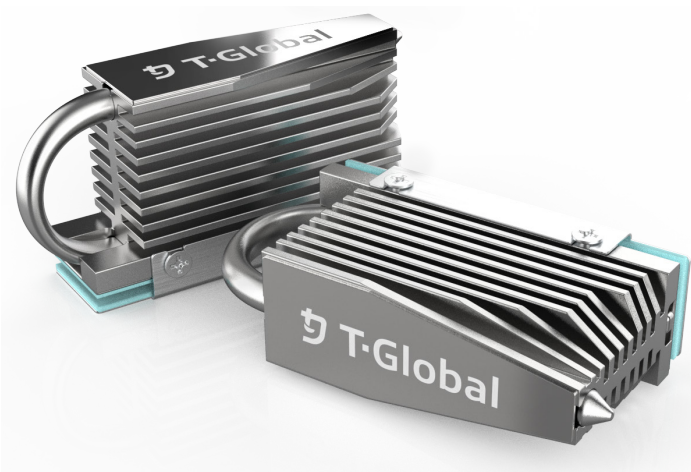




M.2 SSD Thermal Module

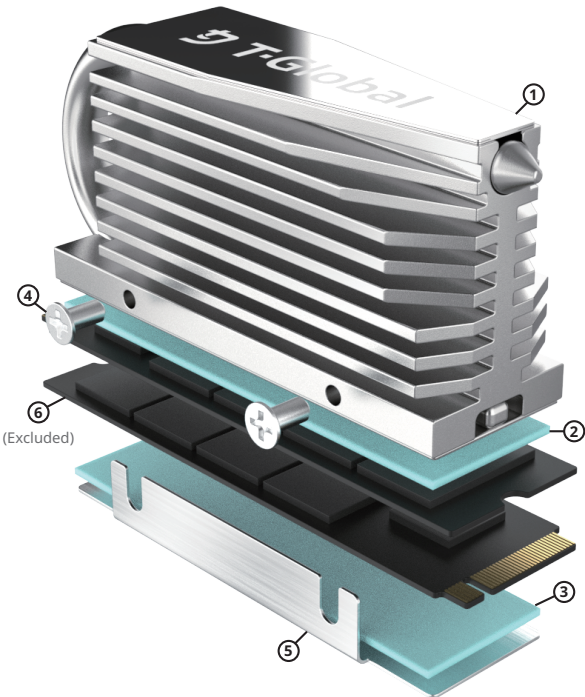
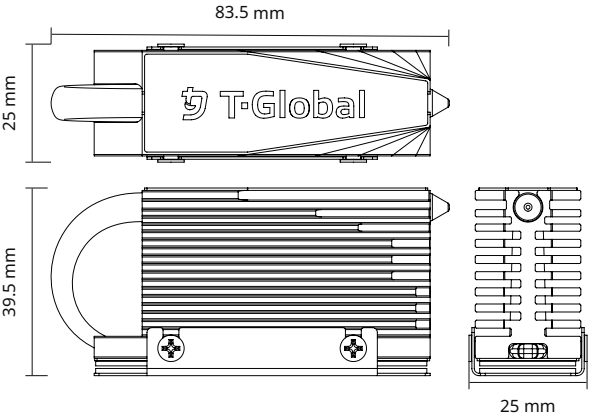
RoHS Compliant

Supported Types

- NVME SSD
- NGFF SATA
- Intel SSD6/7
- Compatible with single sided/double sided M.2 2280 SSD
- Samsung 970 EVO/950Pro/960EVO/XP941/PM951/PM961 SM951/SM961
- Plextor M6e
- Kingston HyperX Predator M.2 SSD

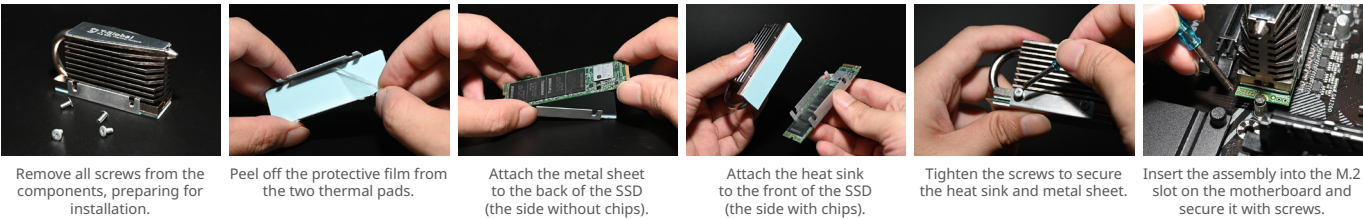
Specifications

Properties	Unit	M.2 SSD Thermal Module
Heatsink Material	-	Aluminum Alloy
Device Type	-	Internal PC Heatsink
Dimensions L x W x H	mm	83.5 x 25 x 39.5 mm ±1
Weight	g	110
Fin Specifications	mm	Thickness 1.7
	mm	Spacing 1.7
Number of Fins	pcs	18
Catheter Diameter	mm	Ø6
Operating Temperature	°C	0~+70
Cooling Range	°C	15~30
Compatibility	-	Compatible with M.2 2280 SSD
Warranty	Year	2



- ① Heat Sink
- ② TG-A6200 Thermal Pad
- ③ TG-A6200 Thermal Pad
- ④ Screw x6
- ⑤ Metal Sheet
- ⑥ Solid State Disk (SSD) (Excluded)

Installation Guide



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